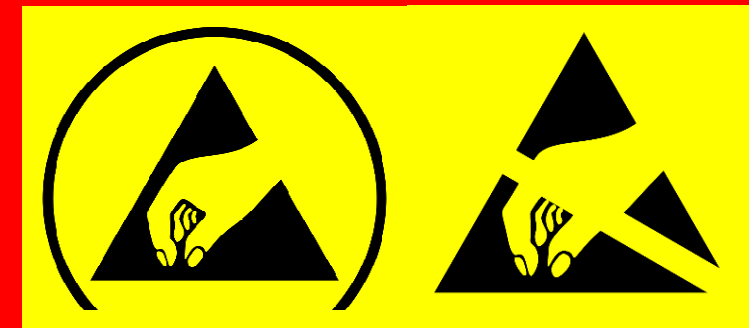
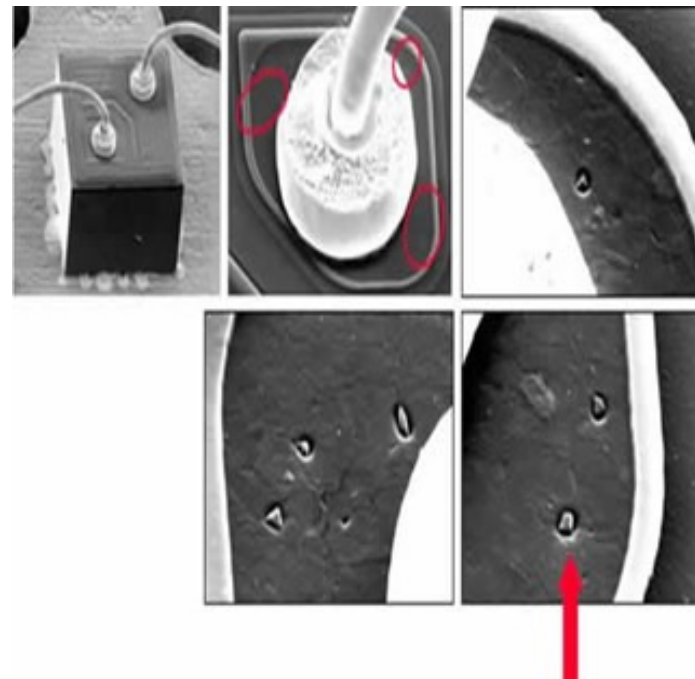
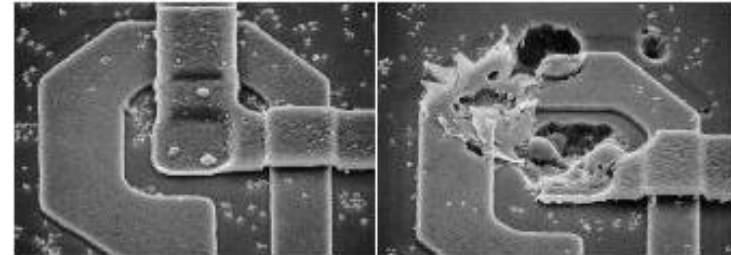
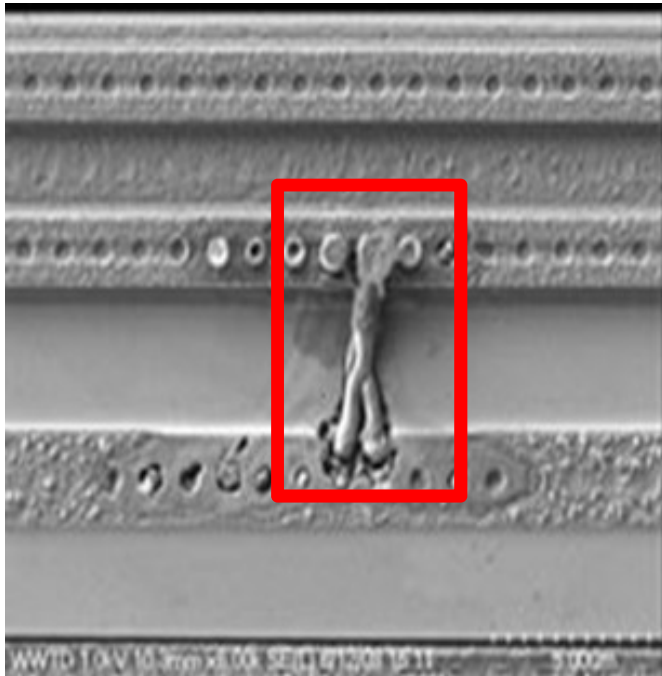


Effective ESD Protection with TVS Diodes

Dipl. Ing. (FH) Robert Demharter



ESD / Transient protection: Damaged Circuits





ESD / Transient protection: Sources of ESD

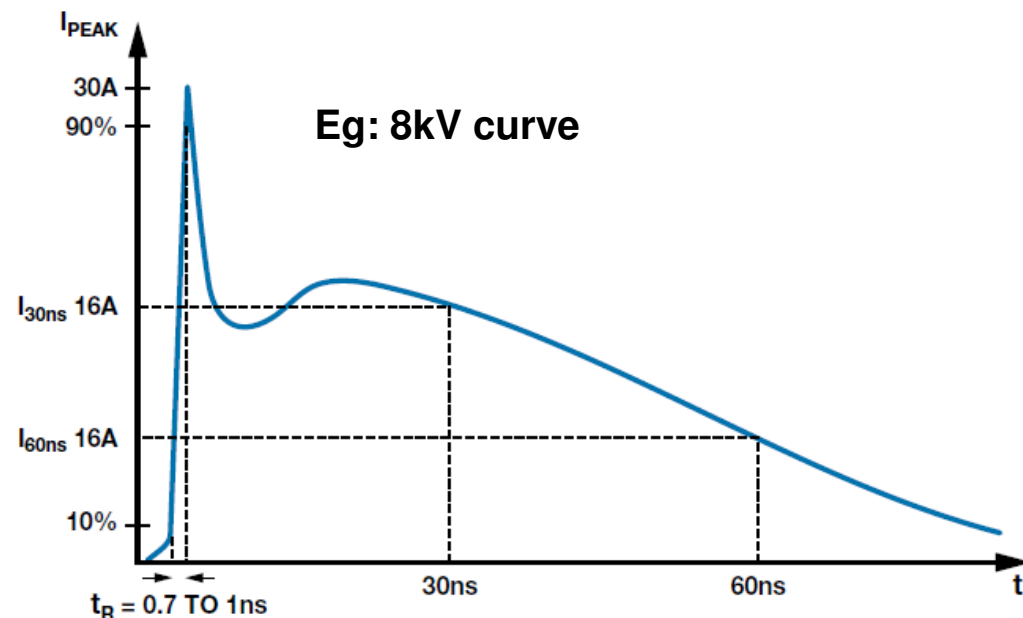
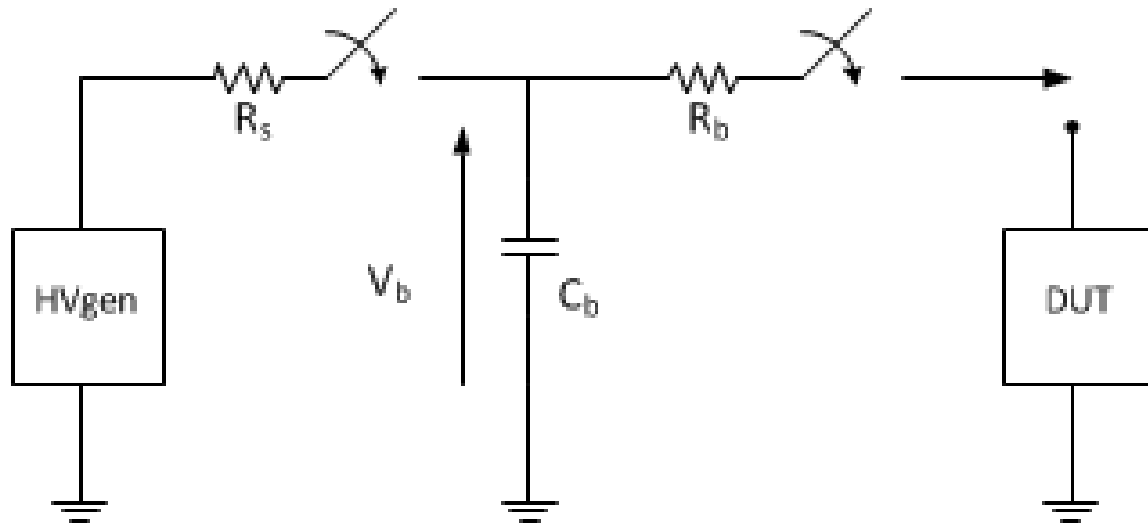
Typical Electrostatic Voltages comes from Triboelectric phenomena:

ESD source	ESD Voltage 10% to 20% Relative Humidity	ESD Voltage 60% to 90% Relative Humidity
Walking across carpet	35 kV	1500 V
Walking on vinyl floor	12 kV	250 V
Worker moving at bench	6 kV	100 V
Opening a vinyl envelope	7 kV	600 V
Picking up common polyethylene bag	20 kV	1200 V
Sitting on chair padded with polyurethane foam	18 kV	1500 V

Source: EMC Engineering - Henry W. Ott (Chapter #15-1- Electrostatic Discharge pag582)

ESD / Transient protection: Test Pulse Setup

- ESD Test Generator is able to produce:
 - Contact discharge/Air discharge
 - 10 positive and 10 negative strikes (int. std)
 Starting from lower level of pulse voltage.
- The curves come out from HBM circuit:



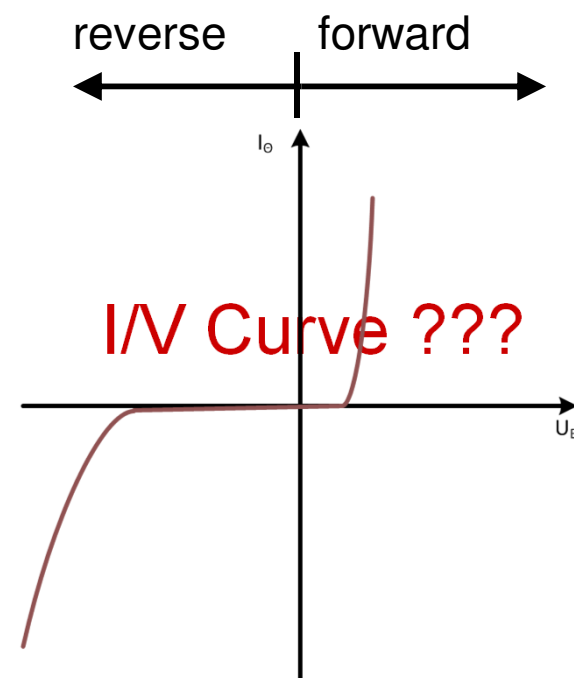
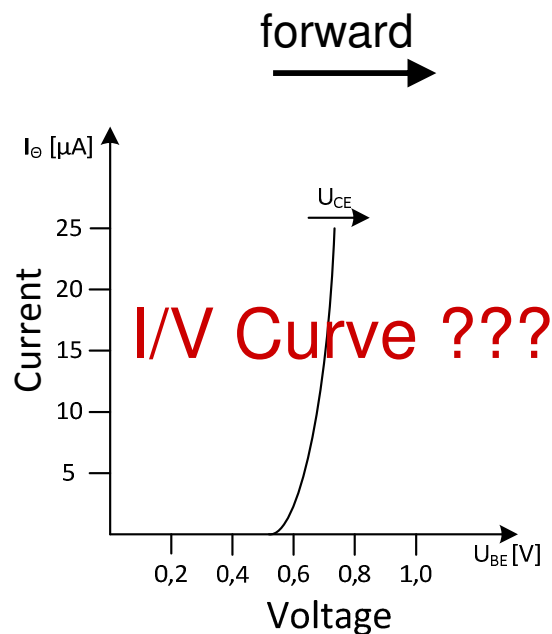
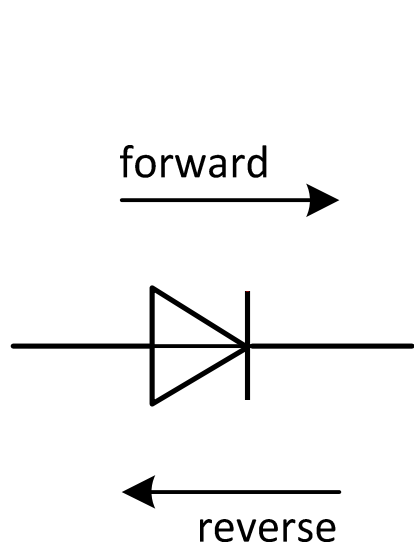
with values for EN 61000-4-2 => $R_s=50-100M\Omega$, $C_b=150pF$, $R_b=330\Omega$, $R_{DUT}=2\Omega$

ESD / Transient protection: Diodes and Zener diodes



A **Diode** is an electrical component, which **lets pass current only in one direction** and blocks current in reverse **direction**.

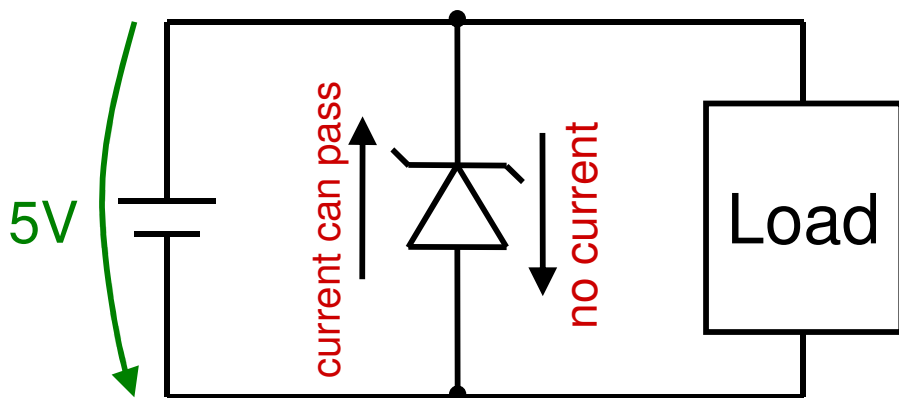
Z-Diodes have same behavior in forward direction, but **in reverse direction they get conducting at defined voltage**.



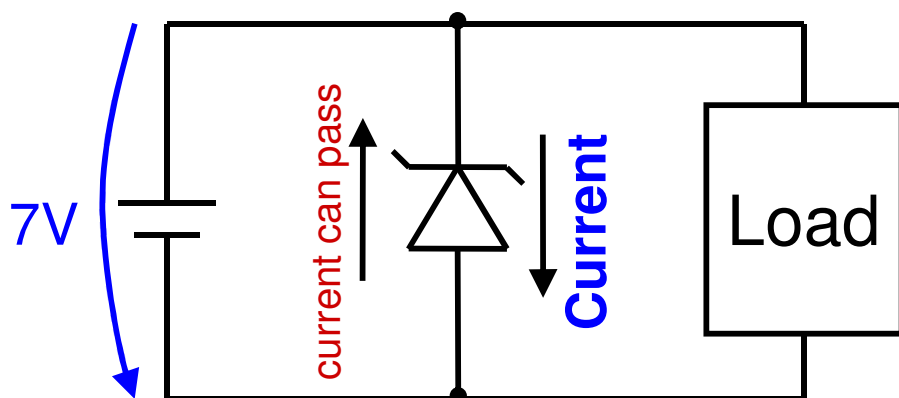
ESD / Transient protection: Diodes and Zener diodes



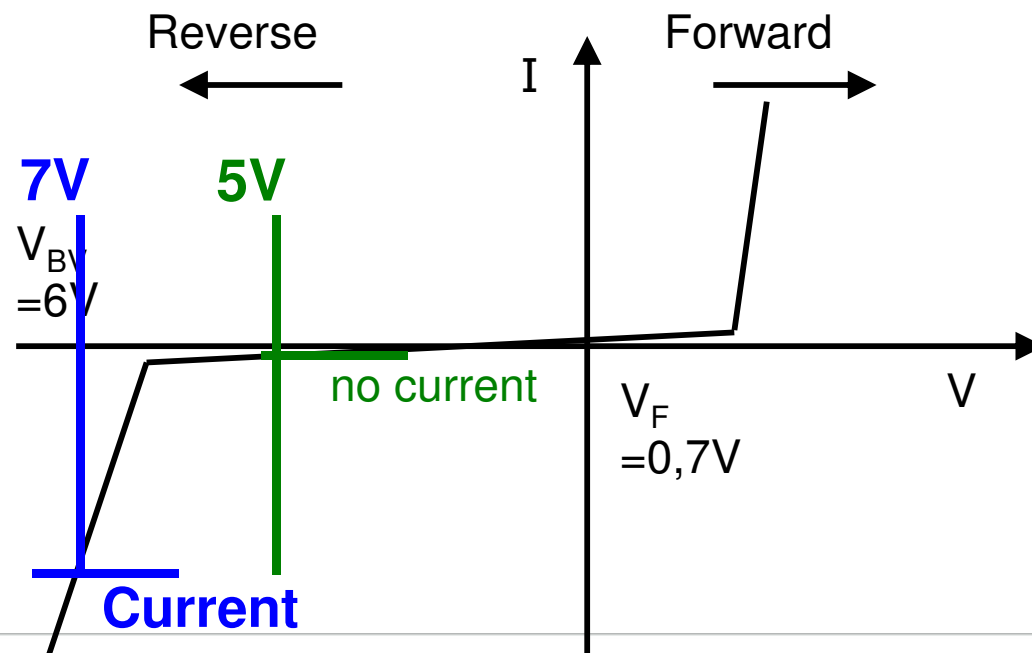
Zener Diodes or TVS Diodes are connected in reverse direction.



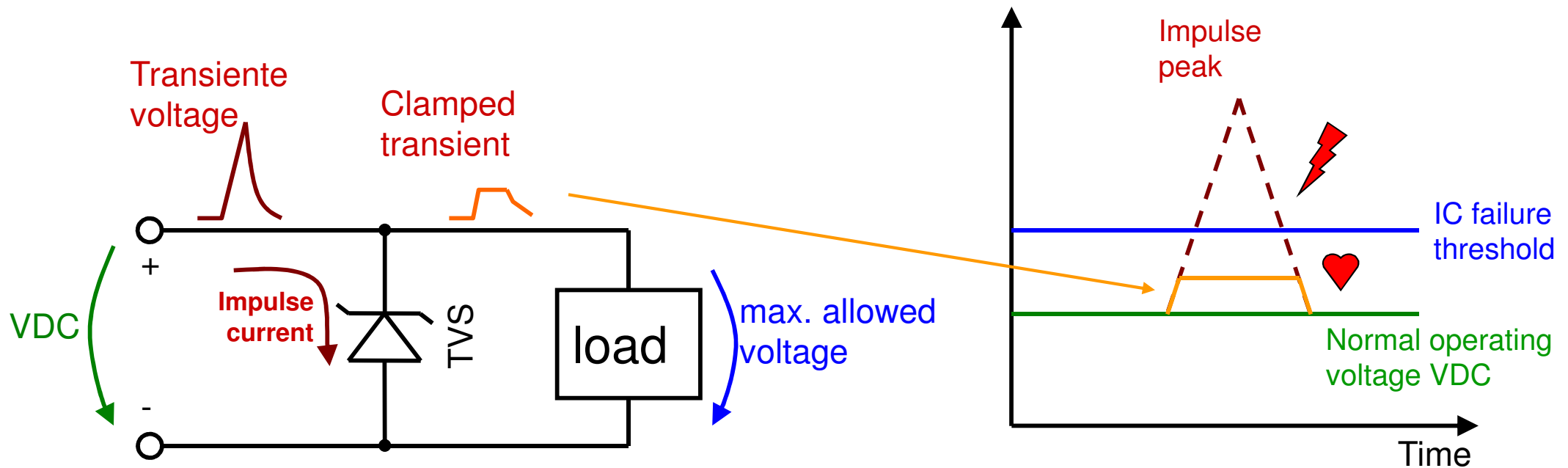
There's no current through the diode due to **breakdown voltage is not exceeded.**



If **voltage is larger than breakdown voltage** there is **current through diode.**

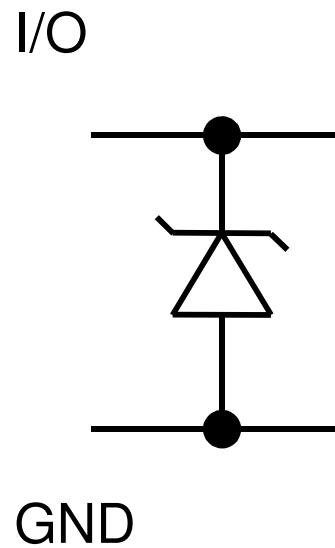


ESD / Transient protection: Scenario

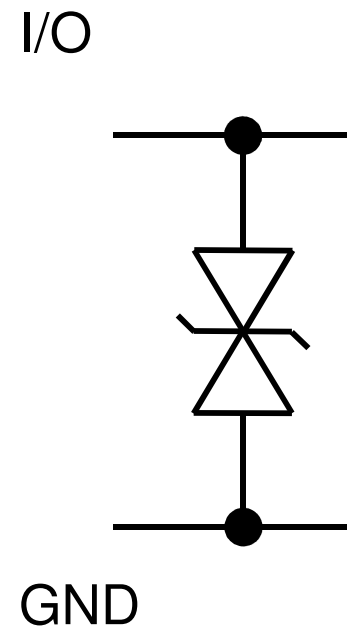


ESD / Transient protection: Topologies

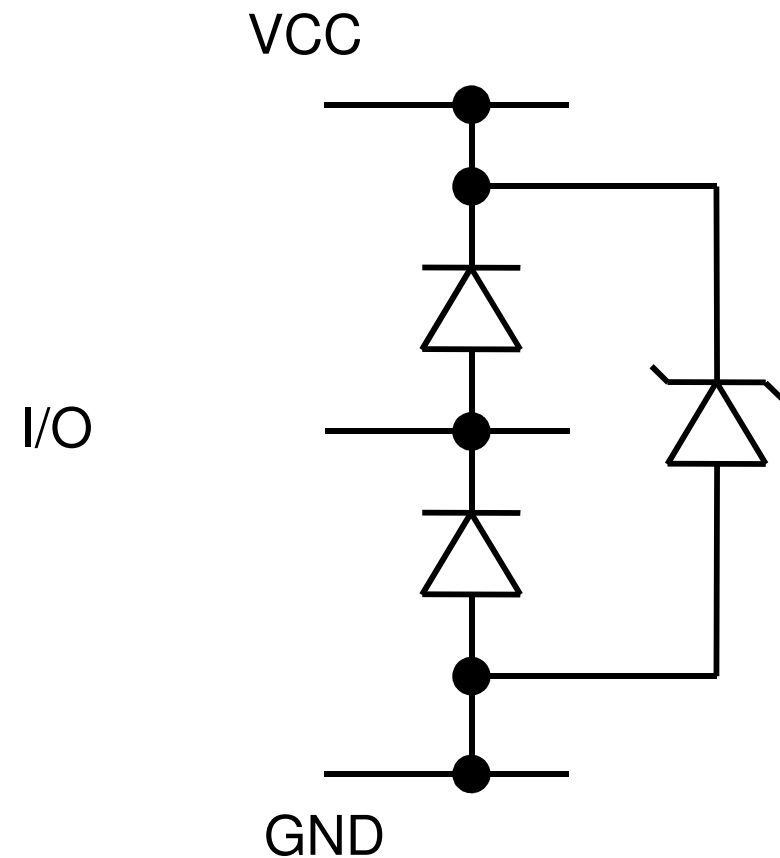
Uni-polar



Bi-polar



Rail-to-Rail





ESD / Transient protection: Topologies differences

Uni- / Bi-directional Protection 824 02x 824 04x	Rail-to-Rail Protection 824 00x 824 01x
Very good ESD Protection Capability	Very good ESD Protection Capability
Good Surge Protection Capability	Poor Surge Protection Capability
Medium- to High-Speed Data Lines	Ultra-High-Speed Data Lines
One Reference Voltage needed	Two Reference Voltages needed
Lower Price per Protected Line	Higher Price per Protected Line



Typical applications: Interface protection

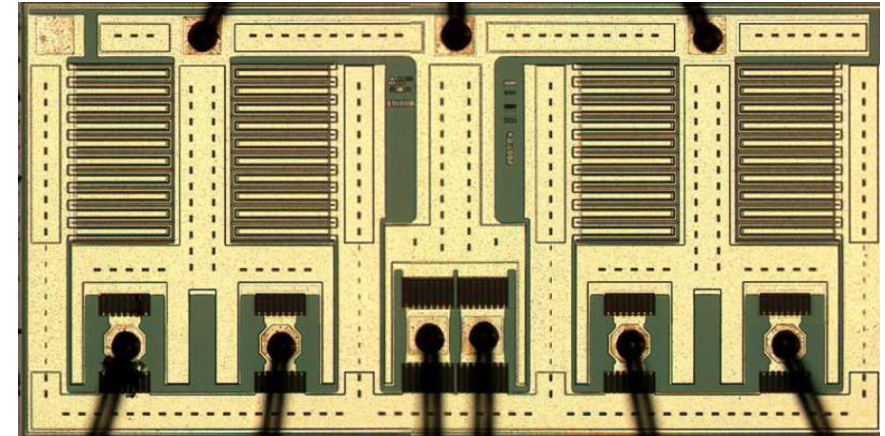
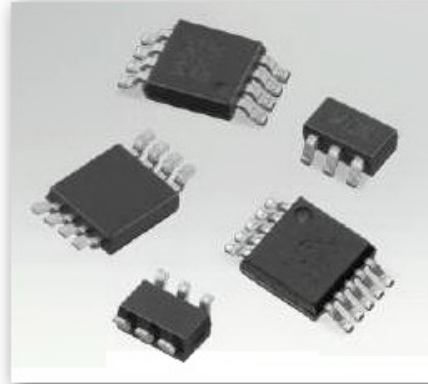
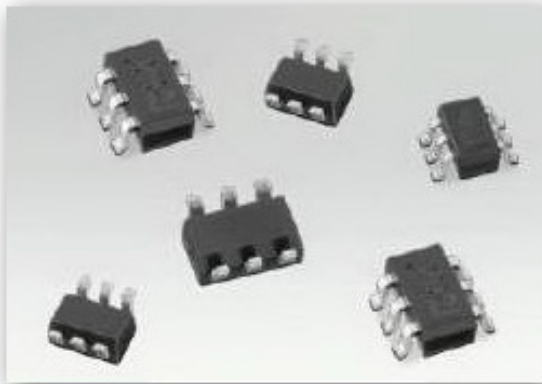
- **USB 1.0 / 2.0 / 3.1**
- **Ethernet**
- **RS-232 / RS-485**
- **CAN**
- **PROFIBUS**
- **Serial ATA**
- **FireWire**
- **DVI**
- **HDMI**
- **...**

ESD / Transient protection: WE products

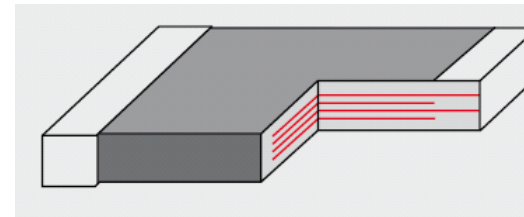
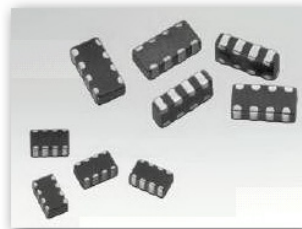


WE-TVS

(Standard Series / High Speed / Super Speed)



WE-VS / WE-VE(ULC)/ WE-VEA(ULC)



ESD / Transient protection: Selection process

ESD suppressor differ from SMD varistor in their lower and specified capacitance.

- 1. Determine the Operating Voltage**
Checking the typical application
- 2. Selection of the correct value of capacitance**
- 3. Checking the max clamping voltage**



The selection of a TVS diode is the same as above with the following differences:

- 1.** TVS can be uni or bi-directional
- 2.** V_{DD} pin has to be connected in some cases



ESD / Transient protection: Selection process

1. Determine the Operating Voltage Checking the typical application

Is it possible to choose a component with a higher permissible op Voltage: the leakage current will be lower but Clamping voltage higher.

Checking the application, will let the choice easier.

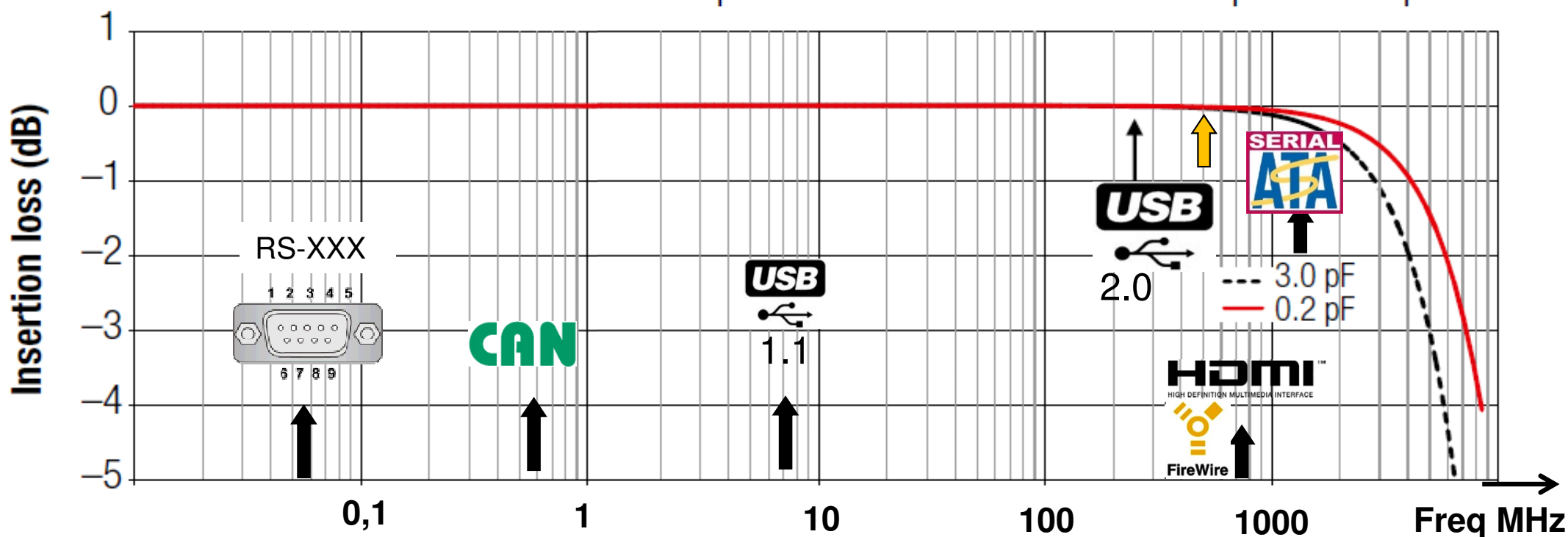
Electrical properties: Size 0402							
Order Code	V _{DC} (V)	C (pF)	V _C (V)	I _{Leak} (μA)	R (MΩ)	Typical Applications	Qty.
823 57 050 100	5	10	60	1	10	USB 1.1/RS-232/LAN 10 Mbit	10000
823 57 050 220	5	22	55			CAN Bus	
823 57 050 330	5	33	55			RS-422	
823 57 050 560	5	56	55			RS-422 & IrDA 1.0	
823 57 120 050	12	5	80			USB 1.1/USB 2.0	
823 57 120 100	12	10	60			USB 1.1/RS-232/LAN 10 Mbit	
823 57 120 220	12	22	55				
823 57 240 010	24	1	200				
823 57 240 030	24	3	180			USB 2.0/LAN 100 Mbit	

ESD / Transient protection: Selection process

2. Selection of the correct value of capacitance

For signal integrity, it is important to select a capacitance to match the data rate.

Comparison of the insertion loss of 0.2 pF and 3.0 pF



ESD / Transient protection: Selection process

3. Checking the max clamping voltage

The Clamping Voltage is a measure for the protection of the ESD suppressor. This should be lower than the voltage stability of the circuit to be protected.

Electrical properties: Size 0402							
Order Code	V_{DC} (V)	C (pF)	V_C (V)	I_{Leak} (μA)	R (M Ω)	Typical Applications	Qty.
823 57 050 100	5	10	60	1	10	USB 1.1/RS-232/LAN 10 Mbit	10000
823 57 050 220	5	22	55			CAN Bus	
823 57 050 330	5	33	55			RS-422	
823 57 050 560	5	56	55			RS-422 & IrDA 1.0	
823 57 120 050	12	5	80			USB 1.1/USB 2.0	
823 57 120 100	12	10	60			USB 1.1/RS-232/LAN 10 Mbit	
823 57 120 220	12	22	55				
823 57 240 010	24	1	200				
823 57 240 030	24	3	180			USB 2.0/LAN 100 Mbit	

ESD / Transient protection: TVS Selection process



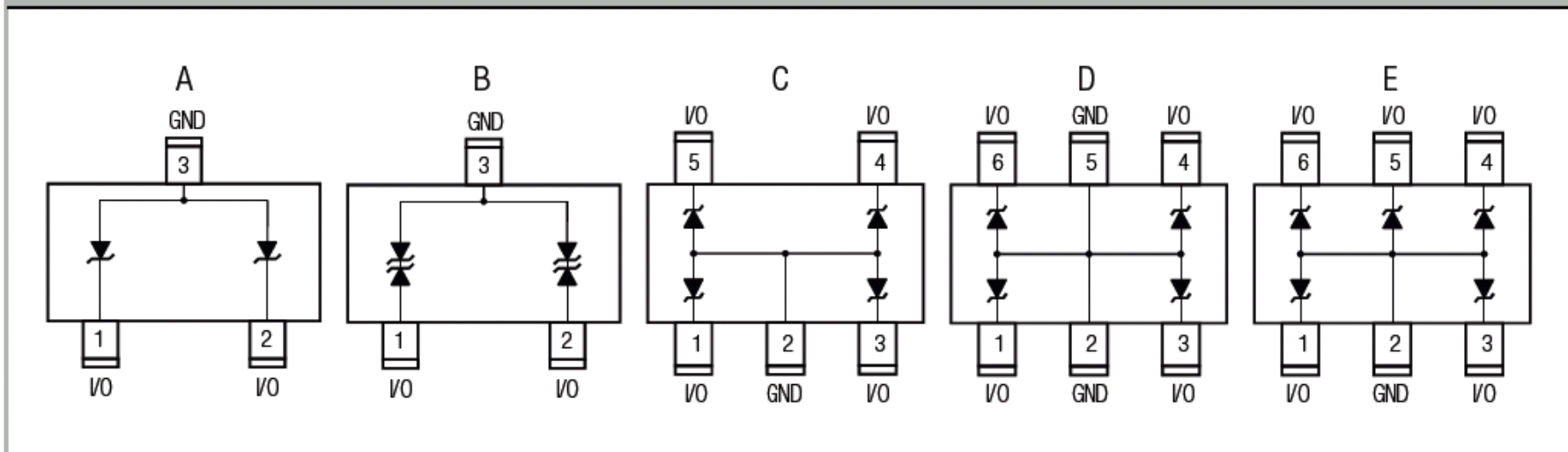
Electrical properties (3.3 V Operating Systems)

The selection could be done also for uni- or bi-directional behaviour.

Schematic A for unidirectional

Schematic B-C-D-E for bi-directional

Schematics



824 001

SOT23-6L

6.2

1.0

5

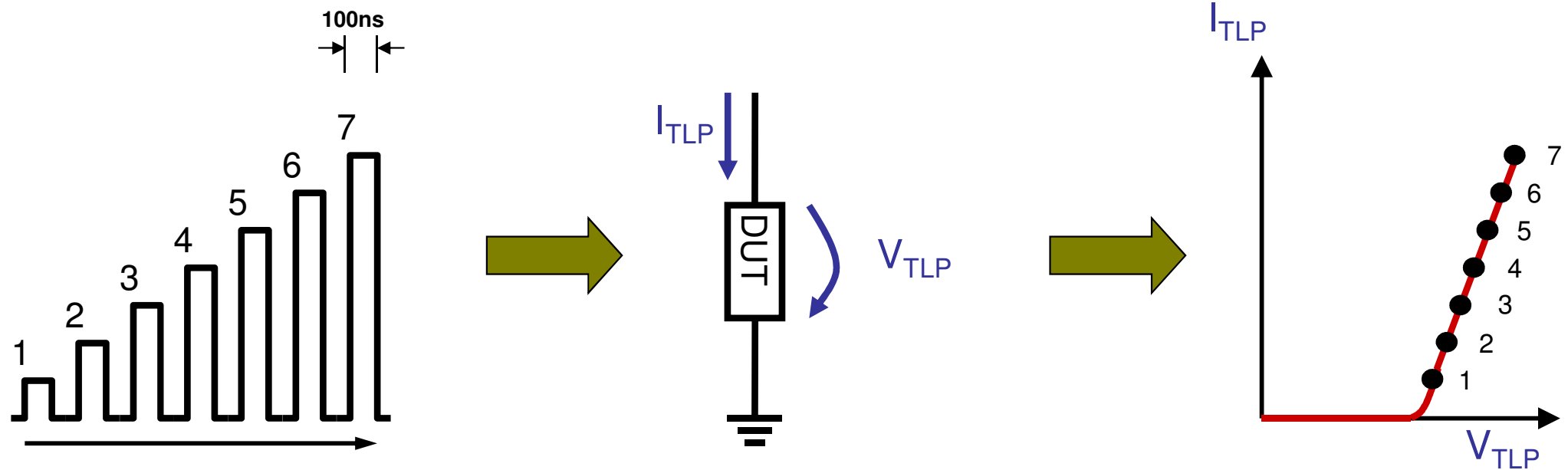
2

9.0

14

p ESD (kV)	V ESD Air/Contact (kV)
0.5	16/12
3	20/12
	15/8

TLP – Transmission Line Pulsing

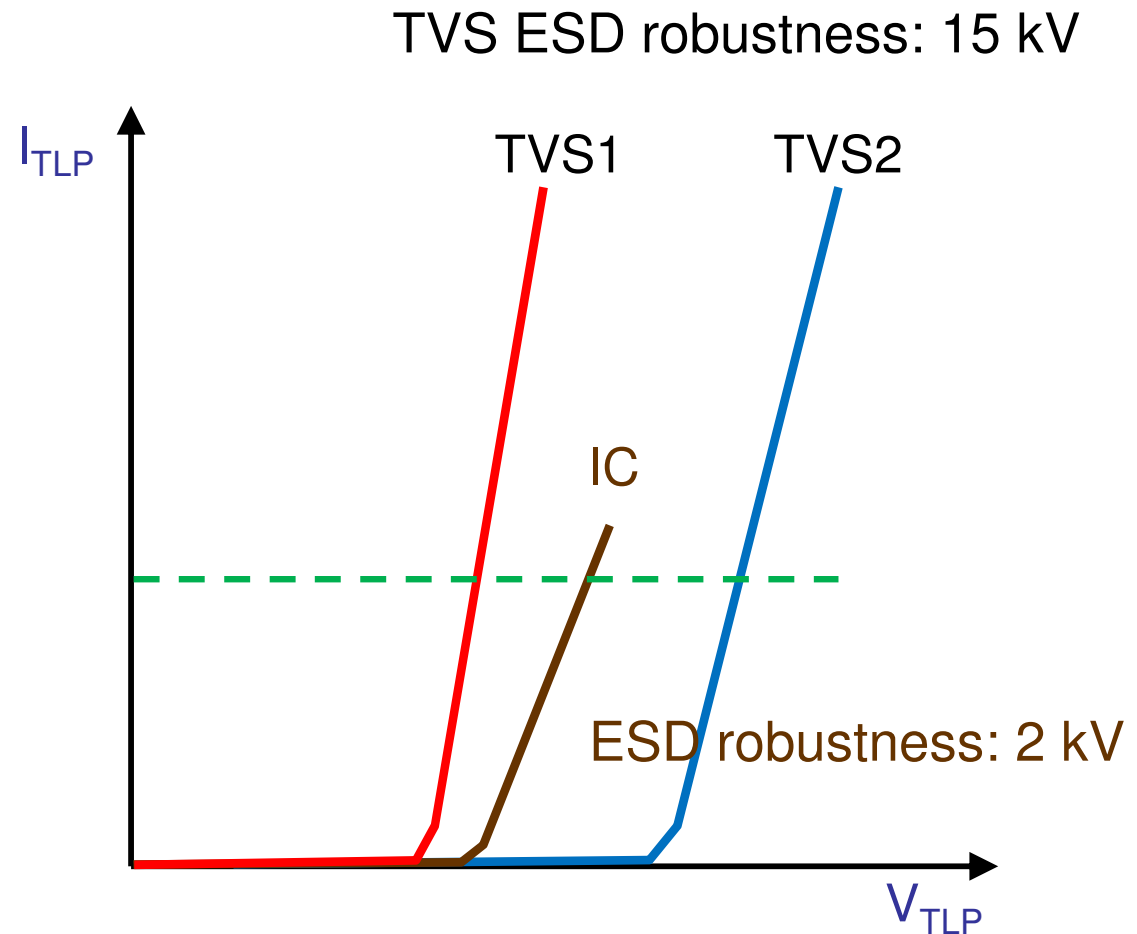


TVS vs IC: Improve ESD Robustness

Theory vs. Reality

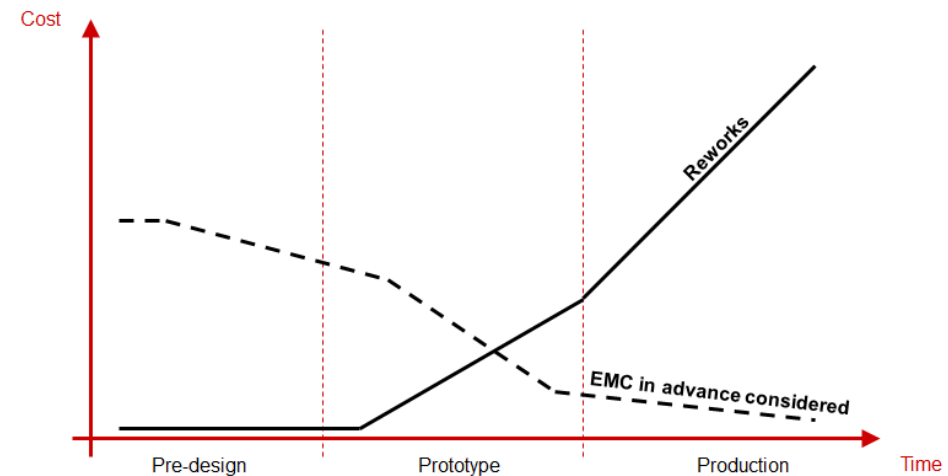


Who protects who ??



ESD / Transient protection: Rationale

- ESD protection should be part of the original system design
- ESD hardening of a system involves the electrical, mechanical
- Digital circuits are more sensitive to ESD upset than analog circuits
- ESD has a spectral content until 4 GHz frequency range
- Ribbon cables are especially susceptible to ESD (textile WE-TS could be useful)
- All loop areas on PCB should be kept as small as possible
- Ferrites can be effective in limiting ESD currents





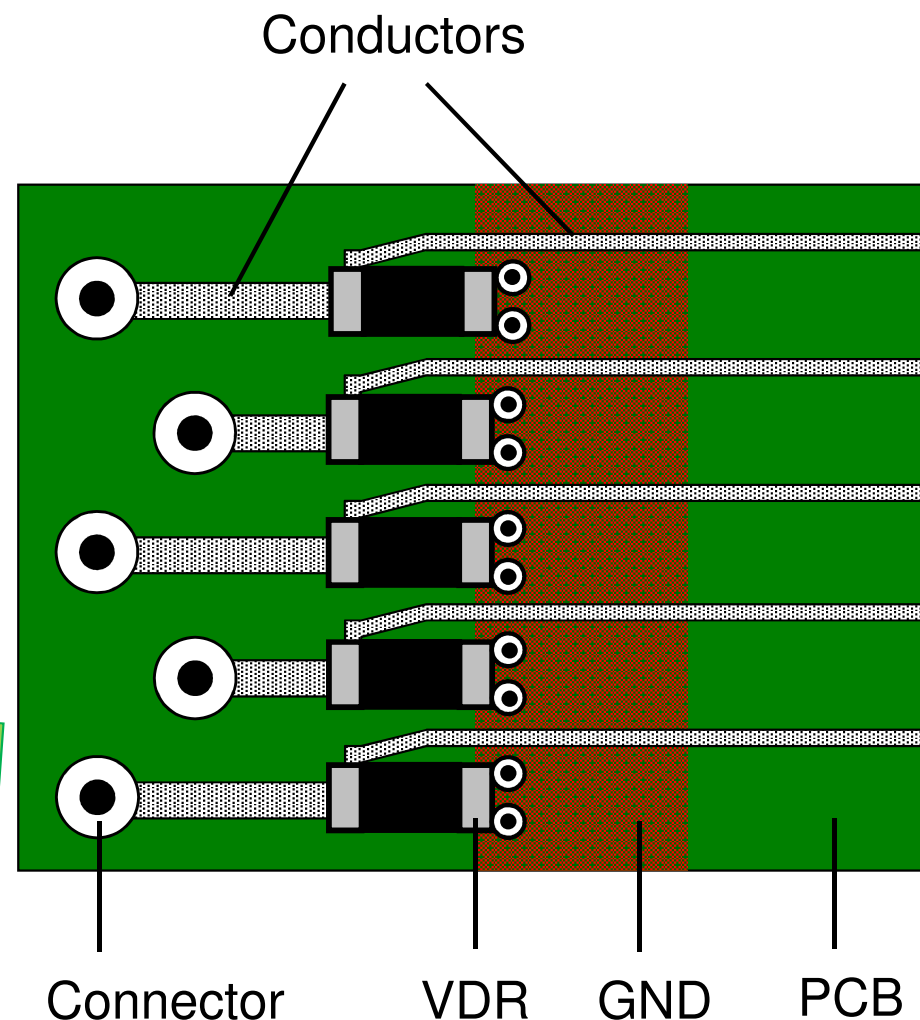
ESD PCB LAYOUT RECOMMENDATIONS

PCB Layout recommendations: Suppressors placing



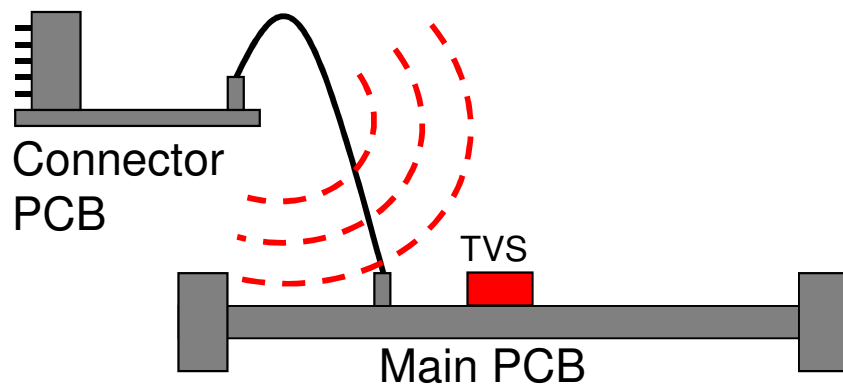
- The conductor tracks from the connector to the ESD suppressor are short and wide, if possible => low inductance.
- ESD suppressor is connected with the other pin onto a big ground plane to operate properly.
- No other conductor track is allowed to cross between the connector and the ESD suppressor => no superimposed ESD pulse to be transferred and propagate on the circuit board.

D-SUB connector layout

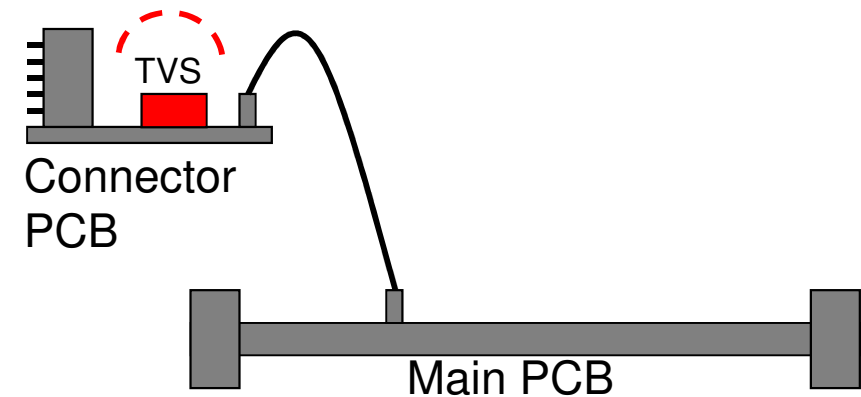


PCB Layout recommendations: TVS placing

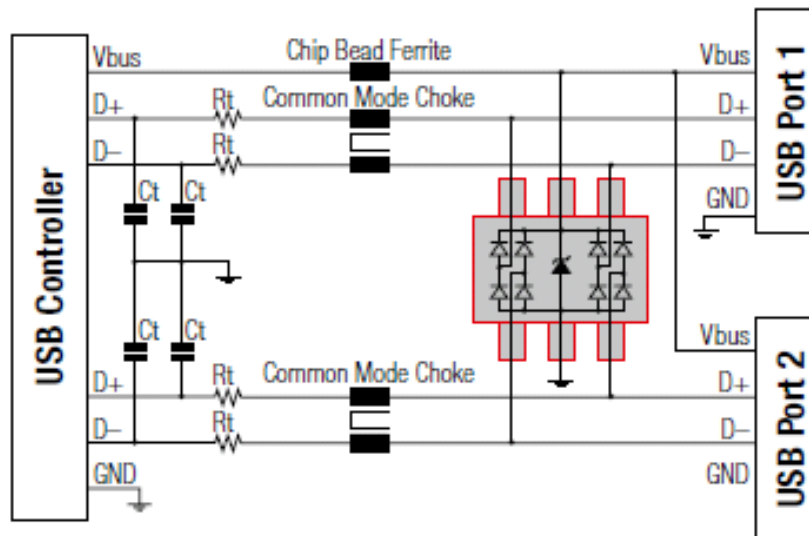
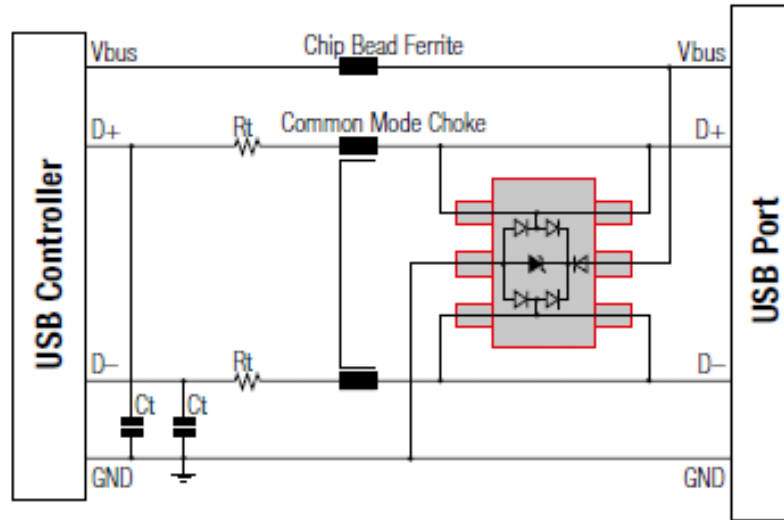
Not good



Good

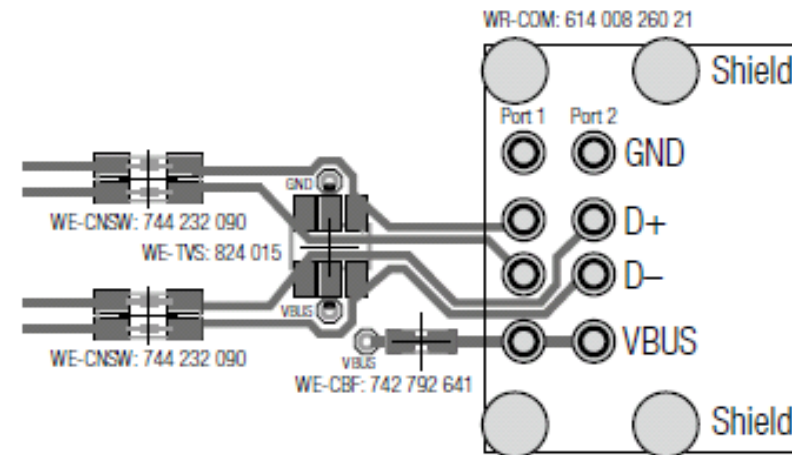
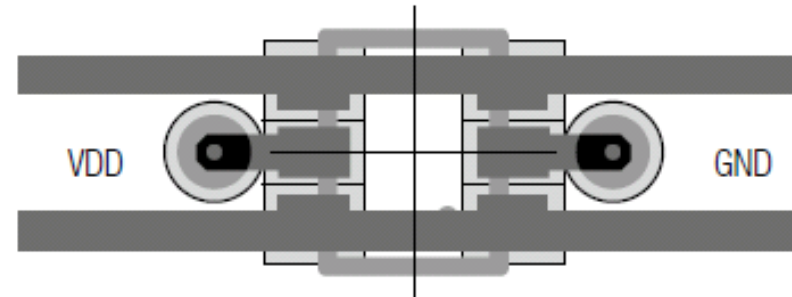


USB 2.0 : With TVS

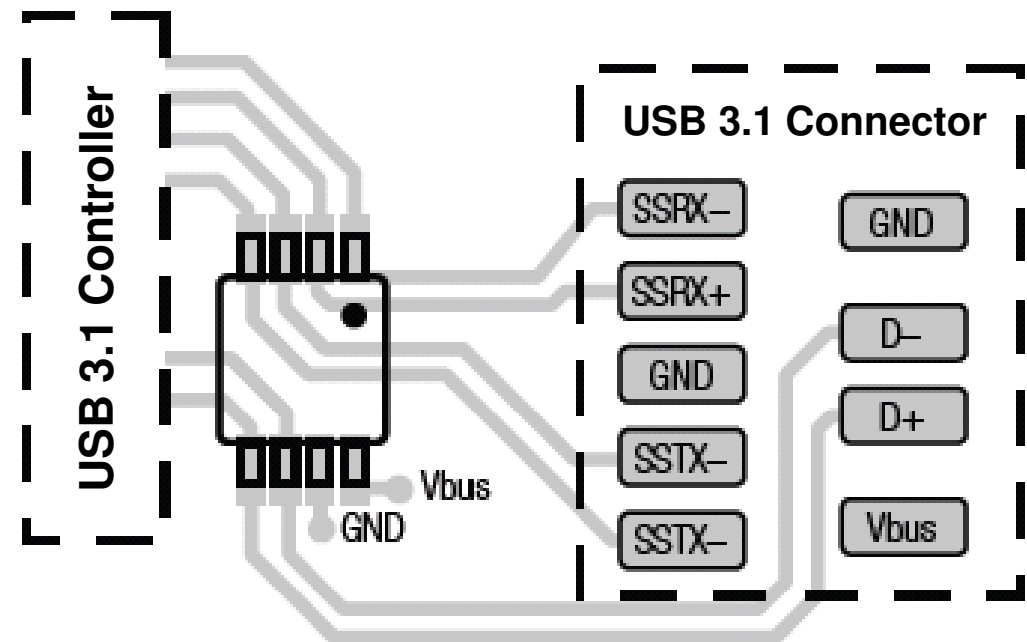
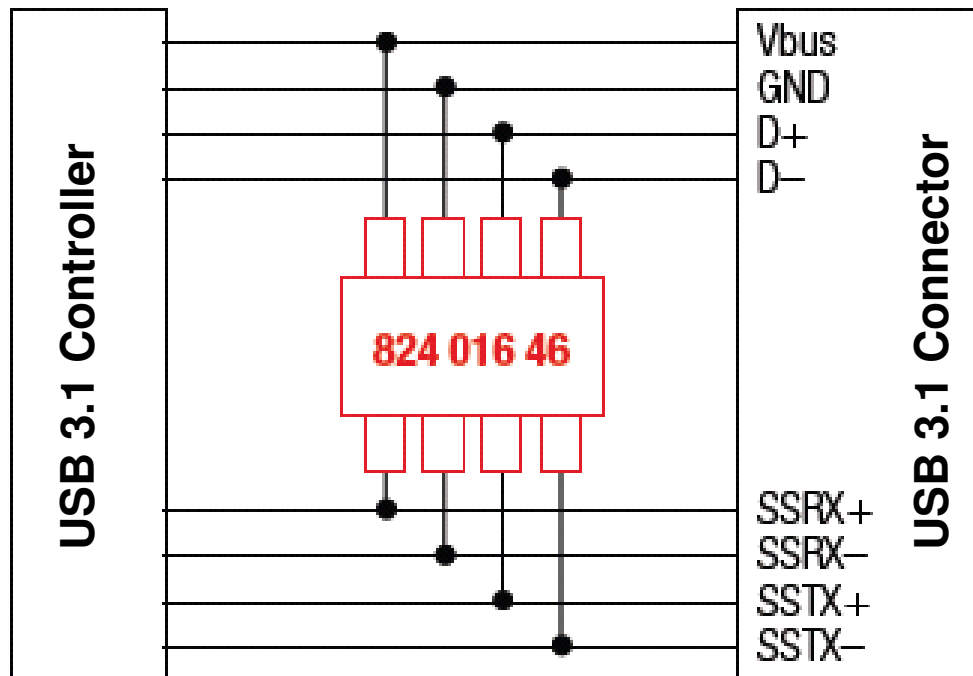


Flow Thru Design

WE-TVS: 824 001x

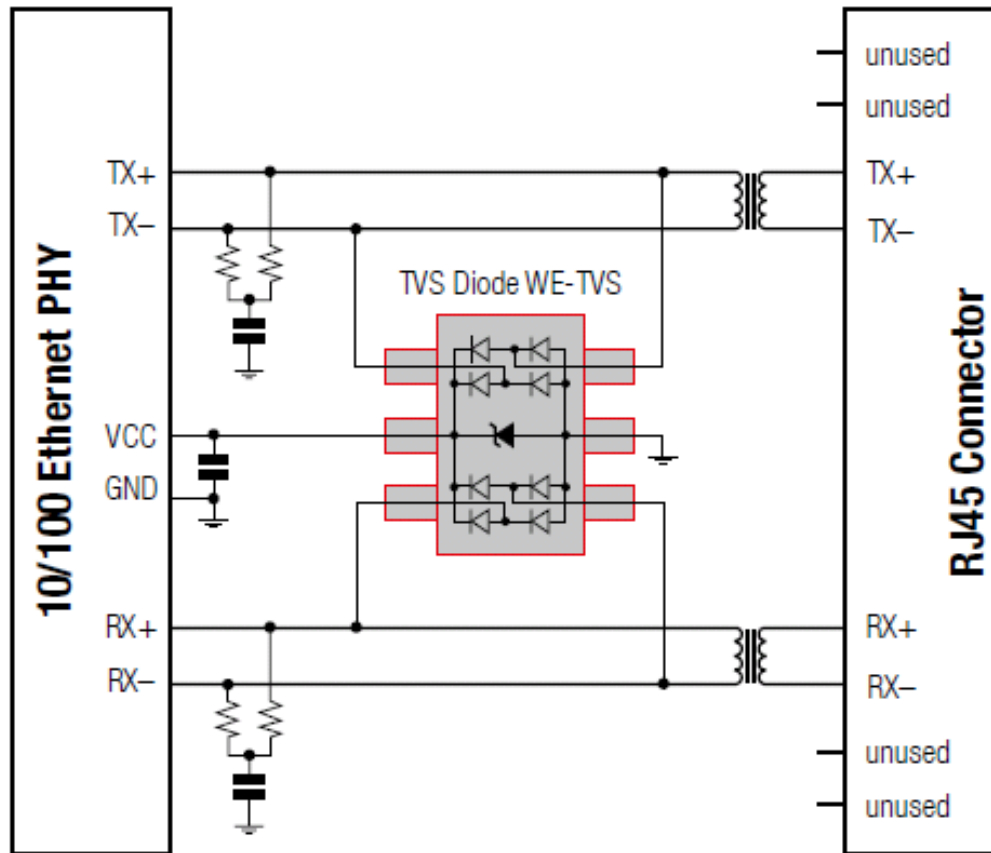


USB 3.1 : with TVS

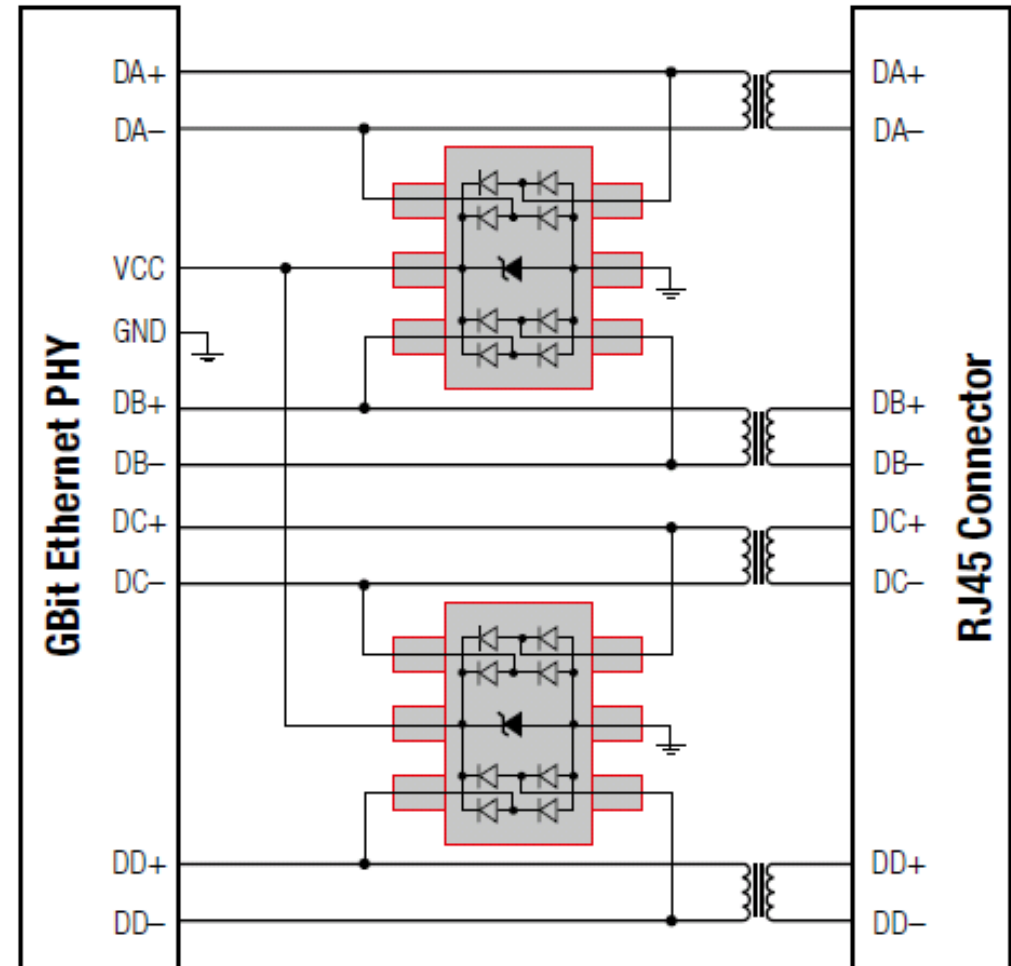


Ethernet: with TVS

10/100BaseT



1000BaseT





Thank you for your attention!
Any questions?



Bibliography

- **1)Protek Device website** (http://www.protekdevices.com/Knowledge_Base/technical_articles.php)
- **2)EMC Engineering - Henry W. Ott** (Chapter #15)
- **3)EMC Engineering - Henry W. Ott** (Chapter #14.3 - Transient Immunity pag557-575)
- **4)Trilogy of Magnetics** (from page 311 up to 349)
- **5)(only Images) Analog Devices - Safeguard Your RS-485 Communication Networks from Harmful EMC Events**(http://www.analog.com/library/analogdialogue/archives/47-05/rs485_emc.pdf)
- **6) Glen Wallis - EMC presentation november 2010**
- **7) Designers Maximize TVS Diode Performance - Jim Lepkowski**
(<http://powerelectronics.com/site-files/powerelectronics.com/files/archive/powerelectronics.com/mag/603PET25.pdf>)
- **8)(only Images) <http://www.scantech7.com/esd-electrostatic-discharge-testing-sensitive-equipment-electronics/>** (transistor damage)
- **9)(only Images)<http://slideplayer.com/slide/6051683/>**